

III Year - II Semester	L	Т	Р	С
III I cai - II Semester	3	0	0	3

WIRED and WIRELESS TRANSMISSION DEVICES

Course objectives:

The student will be able to

- understand the applications of the electromagnetic waves in freespace.
- introduce the working principles of various types of antennas
- discuss the major applications of antennas with an emphasis on how antennas are employed to meet electronic systemrequirements.
- understand the concepts of radio wave propagation in theatmosphere.

UNIT I

MICROWAVE TRANSMISSION LINES: Introduction, Microwave Spectrum and Bands, Applicationsof Microwaves. Rectangular Waveguides – TE/TM mode analysis, Expressions for Fields, Characteristic Equation and Cut-off Frequencies, Filter Characteristics, Dominant and Degenerate Modes, Sketches of TE and TM mode fields in the cross-section, Mode Characteristics – Phase and Group Velocities, Wavelengths and Impedance Relations; Power Transmission and Power Losses in Rectangular Guide, Impossibility of TEM mode.Related Problems, Excitation techniques-waveguides

MICROSTRIP LINES– Introduction, Z_0 Relations, Effective Dielectric Constant, Losses, Q factor

UNIT II

ANTENNA FUNDAMENTALS: Introduction, Radiation Mechanism – single wire, 2 wire, dipoles, Current Distribution on a thin wire antenna. Antenna Parameters - Radiation Patterns, Patterns in Principal Planes, Main Lobe and Side Lobes, Beam widths, Polarization, Radiation Intensity, Directivity, Gain Antenna Apertures, Aperture Efficiency, Effective Height, illustrated Problems.

UNIT III

THIN LINEAR WIRE ANTENNAS: Retarded Potentials, Radiation from Small Electric Dipole, Quarter wave Monopole and Half wave Dipole – Current Distributions, Evaluation of Field Components, Power Radiated, Radiation Resistance, Beam widths, Directivity, Effective Area and Effective Height, Antenna Theorems – Applicability and Proofs for equivalence of directional characteristics, Loop Antennas: Small Loops - Field Components, Concept of short magnetic dipole, D and Rr relations for smallloops.

ANTENNA ARRAYS: Principle of Pattern Multiplication, N element Uniform Linear Arrays – Broadside, End-fire Arrays, Binomial Arrays, Arrays with Parasitic Elements. Yagi-Uda Arrays, Folded Dipoles and their characteristics.

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UNIT IV

NON-RESONANT RADIATORS: Introduction, Traveling wave radiators, Long wire antennas, Rectangular Patch Antennas –Geometry and Parameters, Impact of different parameters on characteristics. Helical Antennas, Geometry, basic properties

VHF, UHF AND MICROWAVE ANTENNAS: Reflector Antennas: Corner Reflectors. Parabolic Reflectors – Geometry, characteristics, types of feeds, F/D Ratio, Spill Over, Back Lobes, Aperture Blocking, Cassegrain Feeds.

Horn Antennas – Types, Optimum Horns, Lens Antennas – Geometry, Features, Dielectric Lenses and Zoning, Applications.

UNIT V

WAVE PROPAGATION: Concepts of Propagation – frequency ranges and types of propagations. Ground Wave Propagation–Characteristics, Fundamental Equation for Free-Space Propagation, Basic Transmission Loss Calculations, Space Wave Propagation–Mechanism, LOS and Radio Horizon, Tropospheric Wave Propagation – Radius of Curvature of path, Effective Earth's Radius, Effect of Earth's Curvature, Field Strength Calculations. **ANTENNA MEASUREMENTS** – Patterns, Set Up, Distance Criterion, Directivity, VSWR, Impedance and Gain Measurements (Comparison, Absolute and 3-Antenna Methods)

TEXT BOOKS

- 1. Electromagnetic Waves and Radiating Systems E.C. Jordan and K.G. Balmain, PHI, 2nd Edition,2000.
- 2. Antennas and wave propagation- Sisir K Das, Annapurna Das, TMH, 2013.

REFERENCES

- 1. Antennas John D. Kraus, McGraw-Hill, 2nd Edition, 1988.
- 2. Transmission and Propagation E.V.D. Glazier and H.R.L. Lamont, The Services Text Book of Radio, vol. 5, Standard Publishers Distributors, Delhi, 2009.
- 3. Antennas and wave propagation by Prof G S N Raju, Pearsion Publications, First impression, 2016

Course Outcomes:

After going through this course the student will be able to

- Identify basic antennaparameters.
- Design and analyze wire antennas, loop antennas, reflector antennas, lens antennas, horn antennas and micro stripantennas
- Quantify the fields radiated by various types of antennas
- Design and analyze antennaarrays
- Analyze antenna measurements to assess antenna'sperformance
- Identify the characteristics of radio wavepropagation



III Year - II Semester		L	Τ	P	С
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	VI CL DECICN				
	VLSI DESIGN				

OBJECTIVES:

The main objectives of this course are:

- To learn the MOS Process Technology
- To understand the operation of MOS devices
- Understand and learn the characteristics of CMOS circuit construction.
- Describe the general steps required for processing of CMOS integrated circuits.
- To impart in-depth knowledge about analog and digital CMOS circuits.

UNIT-I:

INTRODUCTION AND BASIC ELECTRICAL PROPERTIES OF MOS CIRCUITS: VLSI Design Flow, Introduction to IC technology, Fabrication process: nMOS, pMOS and CMOS. I_{ds} versus V_{ds} Relationships, Aspects of MOS transistor Threshold Voltage, MOS transistor Trans, Output Conductance and Figure of Merit. nMOS Inverter, Pull-up to Pull-down Ratio for nMOS inverter driven by another nMOS inverter, and through one or more pass transistors. Alternative forms of pull-up, The CMOS Inverter, Latch-up in CMOS circuits, Bi-CMOS Inverter, Comparison between CMOS and BiCMOS technology, MOS Layers, Stick Diagrams, Design Rules and Layout, Layout Diagrams for MOS circuits

UNIT-II:

BASIC CIRCUIT CONCEPTS: Sheet Resistance, Sheet Resistance concept applied to MOS transistors and Inverters, Area Capacitance of Layers, Standard unit of capacitance, some area Capacitance Calculations, The Delay Unit, Inverter Delays, driving large capacitive loads, Propagation Delays, Wiring Capacitances, Choice of layers.

SCALING OF MOS CIRCUITS: Scaling models and scaling factors, Scaling factors for device parameters, Limitations of scaling, Limits due to sub threshold currents, Limits on logic levels and supply voltage due to noise and current density. Switch logic, Gate logic.

UNIT-III:

BASIC BUILDING BLOCKS OF ANALOG IC DESIGN: Regions of operation of MOSFET, Modelling of transistor, body bias effect, biasing styles, single stage amplifier with resistive load, single stage amplifier with diode connected load, Common Source amplifier, Common Drain amplifier, Common Gate amplifier, current sources and sinks.

UNIT-IV:

CMOS COMBINATIONAL AND SEQUENTIAL LOGIC CIRCUIT DESIGN:

Static CMOS Design: Complementary CMOS, Rationed Logic, Pass-Transistor Logic. **Dynamic CMOSDesign:** Dynamic Logic-Basic Principles, Speed and Power Dissipation of Dynamic Logic,

Issues in Dynamic Design, Cascading Dynamic Gates, Choosing a Logic Style,



Gate Design in the Ultra Deep-Submicron Era, Latch Versus Register, Latch based design, timing decimation, positive feedback, instability, Metastability, multiplexerbased latches, Master-Slave Based Edge Triggered Register, clock to q delay, setup time, hold time, reduced clock load master slave registers, Clocked CMOSregister. Cross coupled NAND and NOR, SR Master Slave register, Storage mechanism, pipelining

UNIT-V:

FPGA DESIGN: FPGA design flow, Basic FPGA architecture, FPGA Technologies, Introduction to FPGA Families.

INTRODUCTION TO ADVANCED TECHNOLOGIES: Giga-scale dilemma, Short channel effects, High–k, Metal Gate Technology, FinFET, TFET.

TEXTBOOKS:

- 1. Essentials of VLSI Circuits and Systems Kamran Eshraghian, Douglas and A. Pucknell And SholehEshraghian, Prentice-Hall of India Private Limited, 2005 Edition.
- 2. Design of Analog CMOS Integrated Circuits by BehzadRazavi, McGraw Hill, 2003
- 3. Digital Integrated Circuits, Jan M. Rabaey, Anantha Chandrakasan and Borivoje Nikolic, 2nd edition, 2016.

REFERENCES:

- 1. "Introduction to VLSI Circuits and Systems", John P. Uyemura, John Wiley & Sons, reprint 2009.
- Integrated Nanoelectronics: Nanoscale CMOS, Post-CMOS and Allied Nanotechnologies Vinod Kumar Khanna, Springer India, 1st edition, 2016.
- 3. FinFETs and other multi-gate transistors, ColingeJP, Editor New York, Springer, 2008.

OUTCOMES:

At the end of this course the student will be able to:

- Demonstrate a clear understanding of CMOS fabrication flow and technology scaling.
- Apply the design Rulesand draw layout of a given logic circuit.
- Design MOSFET based logic circuit.
- Design basic building blocks in Analog IC design.
- Analyze the behaviour of amplifier circuits with various loads.
- Design various CMOS logic circuits for design of Combinational logic circuits.
- Design amplifier circuits using MOS transistors.
- Design MOSFET based logic circuits using various logic styles like static and dynamic CMOS.
- Analyze the behaviour of static and dynamic logic circuits.



III Year - II Semester		L	T P	P	С
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	DIGITAL SIGNAL PROCESSING				

Course Objectives:

The student will be able to

- Analyze the discrete-time signals and systems in time and frequencydomains.
- Know the importance of FFT algorithm for computation of Discrete FourierTransform
- Understand the various implementations of digital filterstructures
- Learn the FIR and IIR Filter designprocedures
- Learn the concepts of DSPProcessors

UNIT I INTRODUCTION: Introduction to Digital Signal Processing: Discrete-time signals & sequences, Classification of discrete-time systems, stability and causality of LTI systems, Response of LTI systems to arbitrary inputs. Solution of linear constant coefficient difference equations. Discrete-time Fourier Transform (DTFT), Frequency domain representation of discrete-time signals and systems. Review of Z-transforms, solution of difference equations using Z-transforms, Systemfunction.

UNIT II DISCRETE FOURIER SERIES & FOURIER TRANSFORMS: Properties of discrete Fourier series, DFS representation of periodic sequences, Discrete Fourier transforms: Properties of DFT, linear filtering methods based on DFT, Fast Fourier transforms (FFT)-Radix-2 decimation-in-time and decimation-in-frequency FFT Algorithms, Inverse FFT, Circular convolution and linear convolution using DFT.

UNIT III DESIGNOF IIRDIGITAL FILTERS& REALIZATIONS: Analog filter

approximations – Butterworth and Chebyshev, Design of IIR Digital filters from analog filters, Design Examples, Analog and Digital frequency transformations. Basic structures of IIR systems, Transposed forms.

UNIT IV DESIGN OF FIR DIGITAL FILTERS & REALIZATIONS:

Characteristics of FIR Digital Filters, Frequency response. Design of FIR Digital Filters using Window technique and Frequency Sampling technique, Comparison of IIR & FIR filters. Basic structures of FIR systems.

UNIT V INTRODUCTION TO DSP PROCESSORS: Introduction to programmable DSPs: Multiplier and Multiplier Accumulator, Modified bus structures and memory access schemes in P-DSPs, Multiple Access Memory, Multiported memory, VLIW architecture, Pipelining, Special addressing modes, On-Chip Peripherals.

Architecture of ARM processors: Technical details of ARM Processors, Introduction to



Cortex-M3 and cortex M4 processors - Processor type, processor architecture, instruction set, block diagram, memorysystems.

TEXT BOOKS:

- 1. Digital Signal Processing, Principles, Algorithms and Applications: John G. Proakis, Dimitris G. Manolakis, Pearson Education/PHI,2007.
- 2. Discrete Time Signal Processing, A. V. Oppenheim and R. W. Schaffer, PHI, 2010.
- 3. Digital Signal Processors, Architecture, Programming and Applications, B.Venkataramani, M. Bhaskar, TMH,2002.
- 4. Digital Signal Processing Using the ARM Cortex M4, Donald S.Reay,2015.

REFERENCE BOOKS:

- 1 Digital Signal Processing: MH Hayes, Schaum's Outlines, TMH,2007.
- 2 Fundamentals of Digital Signal Processing using MATLAB Robert J. Schilling, Sandra L. Harris, Thomson, 2007.
- 3 Digital Signal Processing, Alan V. Oppenheim, Ronald W. Schafer, PHI Ed., 2006
- 4 Digital Signal Processing, Tarun Kumar Rawat by OXFORD Publishers

Course Outcomes:

After going through this course the student will be able to

- Formulate engineering problems in terms of DSPoperations
- Analyze digital signals and systems
- Analyze discrete time signals in frequencydomain
- Design digital filters and implement with different structures
- Understand the keyarchitectural



III Year - II Semester		L	Т	Р	С					
		3	0	0	3					
C	CELLULAR & MOBILE COMMUNICATION									
(Professional Elective 2)										

Course Objectives:

The student will be introduced to:

- Understand the basic cellular concepts like frequency reuse, cell splitting, cell sectoring etc and various cellularsystems.
- Understand the different types of interference s influencing cellular andmobile communication.
- Understand the frequency management, channel assignment and various propagation effects in Cellular environment.
- Understand the different types antennas used at cell site andmobile.
- Understand the concepts of handoff and types of handoffs.
- Understand the architectures of GSM and 3G cellularsystems.

UNIT I

CELLULAR MOBILE RADIO SYSTEMS: Introduction to Cellular Mobile System, uniqueness of mobile radio environment, operation of cellular systems, consideration of the components of Cellular system, Hexagonal shaped cells, Analog and Digital Cellular systems.

CELLULAR CONCEPTS: Evolution of Cellular systems, Concept of frequency reuse, frequency reuse ratio, Number of channels in a cellular system, Cellular traffic: trunking and blocking, Grade of Service; Cellular structures: macro, micro, pico and femto cells; Cell splitting, Cell sectoring.

UNIT II

INTERFERENCE: Types of interferences, Introduction to Co-Channel Interference, real time Co-Channel interference, Co-Channel measurement, Co-channel Interference Reduction Factor, desired C/I from a normal case in a omni-directional Antenna system, design of Antenna system, antenna parameters and their effects, diversity receiver, non-cochannel interference-different types.

UNIT III

FREQUENCY MANAGEMENT AND CHANNEL ASSIGNMENT: Numbering and grouping, setup access and paging channels, channel assignments to cell sites and mobile units: fixed channel and non-fixed channel assignment, channel sharing and borrowing, overlaidcells. **CELL COVERAGE FOR SIGNAL AND TRAFFIC:** Signal reflections in flat and hilly terrain, effect of human made structures, phase difference between direct and reflected paths, straight line path loss slope, general formula for mobile propagation over water and flatopen area, near and long distance propagation, antenna height gain, form of a point to pointmodel.



UNIT IV HANDOFF STRATEGIES:

Concept of Handoff, types of handoff, handoff initiation, delaying handoff, forced handoff, mobile assigned handoff, intersystem handoff, soft and hard hand offs, vehicle locating methods, dropped call rates and their evaluation.

UNIT V

DIGITAL CELLULAR NETWORKS: GSM architecture, GSM channels, multiple access schemes; TDMA, CDMA, OFDMA.3G and 4G Wireless Standards GSM, GPRS, WCDMA, LTE, Wi-MAX, Introduction to 5G standards.

TEXT BOOKS:

- 1. Mobile Cellular Telecommunications W.C.Y. Lee, Tata McGraw Hill, 2nd Edn., 2006.
- 2. Principles of Mobile Communications Gordon L. Stuber, Springer International2nd Edition,2007.
- 3. Advanced Wireless Communications-4G By. Savo G Glisic, John Wiley & Sons Publication 2ndEdition

REFERENCES:

- 1. Wireless Communications Theodore. S. Rapport, Pearson education, 2nd Edn., 2002.
- 2. Wireless Communication and Networking Jon W. Mark and WeihuaZhqung, PHI,2005.
- 3. Fundamentals of Wireless CommunicationBy. David Tse and Pramod Viswanath, Cambridge UniversityPress

Course Outcomes:

At the end of this course the student can able to:

- Identify the limitations of conventional mobile telephone systems; understandthe concepts of cellular systems.
- Understand the frequency management, channel assignment strategies and antennasin cellularsystems.
- Understand the concepts of handoff and architectures of various cellularsystems.



III Year - II Semester		L	Т	Р	С
		3	0	0	3
	DIGITAL IC DESIGN				
	(Professional Elective-2)				

Course objectives:

The main objectives of this course are:

- The student will be able to understand the MOSD esign.
- In this course, students can study Combinational MOS Logic Circuits and Sequential MOSLogicCircuits.
- Another main object of this course is to motivate the graduate students to design andto develop the Digital Integrated Circuits for differentApplications.
- The concepts of Semiconductor Memories, Flash Memory, RAMarrayorganization

UNIT-I

MOS DESIGN: Pseudo NMOS Logic – Inverter, Inverter threshold voltage, output high voltage, Output Low voltage, gain at gate threshold voltage, Transient response, Rise time, Fall time, Pseudo NMOS logic gates, Transistor equivalency, CMOS Inverter logic.

UNIT-II

COMBINATIONAL MOS LOGIC CIRCUITS: MOS logic circuits with NMOS loads, Primitive CMOS logic gates – NOR & NAND gate, Complex Logic circuits design – Realizing Boolean expressions using NMOS gates and CMOS gates, AOI and OIA gates, CMOS full adder, CMOS transmission gates, Designing with Transmission gates.

UNIT-III

SEQUENTIAL MOS LOGIC CIRCUITS: Behaviour of bistable elements, SR Latch, Clocked latch and flip flop circuits, CMOS D latch and edge triggered flip-flop.

DYNAMIC LOGIC CIRCUITS: Basic principle, Voltage Bootstrapping, Synchronous dynamic pass transistor circuits, Dynamic CMOS transmission gate logic, High performance Dynamic CMOS circuits.

UNIT-IV

INTERCONNECT: Capacitive Parasitics, Resistive Parasitics, InductiveParasitics, Advanced Interconnect Techniques.

UNIT-V

SEMICONDUCTOR MEMORIES: Memory Types, RAM array organization, DRAM – Types, Operation, Leakage currents in DRAM cell and refresh operation, SRAM operation Leakage currents in SRAM cells, Flash Memory- NOR flash and NANDflash.



TEXTBOOKS:

- 1. Digital Integrated Circuits A Design Perspective, Jan M. Rabaey, AnanthaChandrakasan, Borivoje Nikolic, 2ndEd., PHI, 2016.
- 2. Digital Integrated Circuit Design Ken Martin, Oxford UniversityPress,2011.

REFERENCES:

- CMOS Digital Integrated Circuits Analysis and Design Sung-Mo Kang, Yusuf Leblebici, TMH, 3rd Ed., 2011.
- 2. CMOS VLSI Design Neil H.E Weste, David harris, Ayan Banerjee 3rdEdition,Pearson,2006.

Course Outcomes:

At the end of this course the student will be able to:

- Understand the concepts of MOSD esign.
- Design and analysis of Combinational and SequentialMOSCircuits.
- Extend the Digital IC Design toDifferentApplications.
- Understand the Concepts of Semiconductor Memories, Flash Memory, RAM arrayorganization



III Year - II Semester		L	Т	Р	С
		3	0	0	3
I	BUSINESS INTELLIGENCE & ANALYT (Professional Elective 2)	ICS			

OBJECTIVE:

To make students to extract insights from large volumes of data in various forms, by employing statistical mathematics techniques for drawing conclusions about that information

UNIT – I

Essentials of Data analysis - Data Collection, Data Cleansing, Data Exploration, Statistical Analysis, Reporting, Decision

Statistical Methods: Arithmetic mean, The Arithmetic mean of grouped Data, The Median, The mode; The variance and standard deviation, Interpretation of SD, Chebyshev's Lemma or Rule (for sample), Skewness and Kurtosis, Skewness and its measurement, Kurtosis and its measurements.

Probability Distribution & Statistical Inference: Elements of Probability, Random Variable, Probability distribution/density functions (Normal, Binomial, Poisson), Point Estimate, Interval Estimate, Testing of hypothesis

UNIT – II

Visualization: Comparison, Distribution, Relationship, Composition, Visual Charts – Bar chart, Column chart, variable width column chart, Line chart, Column histogram, Line histogram, Scatter chart, stacked column chart, stacked 100% column chart, waterfall chart, pie chart, stacked area chart, 3D area chart, stacked 100% area chart, Bubble chart, Geometric Forms, Pictorial Diagrams, ParetoDiagrams

Applications: Graphical representation of data from Battery health monitoring, Indoor Air Quality, CO2 emissions by country/region (Practice using MS-Excel & R/Python)

UNIT – III

Time series Analysis: Characteristics Movements in a time series; Time series models; Measurement of Trend; Secular Trend; Seasonal Movements; Cyclical Movements; Irregular Movements; Long Cycles,

Applications: Analyze the trends of population growth, global temperatures, solar radiation, wind patterns. (Practice using MS-Excel &R/Python).

$\mathbf{UNIT} - \mathbf{IV}$

Business Intelligence and Analytics: What is Business Intelligence and Analytics? The need for BI and analytics, how to determine requirements, Using the BI tools for extracting insights for data driven decisions

Microsoft Power BI - Part I: Understanding key concepts in business intelligence, data analysis, and data visualization. Getting Started with Power BI and Analytics - Creating account, Power BI Desktop, Working with Data - Connect, Import, Shape and Transform data, Creating Visualization, AuthorReportsandScheduleautomatedrefreshofreports, PublishingDatatoBI



online, Using Quick Insights, Use natural language queries, Create real-time dashboards, Create custom visualizations which can be re-usable in reports and dashboards, Sharing dashboard effectively based on needs.

UNIT – V

Microsoft Power BI - Part II: Exploring live connections to data with Power BI, connecting directly to data bases, Introduction to Power BI Development API, Leveraging custom visuals in Power BI, Introduction to DAX

TEXTBOOKS:

- 1. Statistics Concepts and applications, Nabendu pal & Sahadeb sarkar, PHI Learning Pvt. Ltd.,2008.
- 2. Effective Data Visualization: The Right Chart for the Right Data 1st Edition, Dr. Stephanie D. H. Evergreen, SAGEPublications
- 3. Introducing Microsoft Power BI, Alberto Ferrari and Marco Russo, 2016.

REFERENCE BOOKS

- 1. Applied Microsoft Power BI: Bring your data to life! Teo Lachev, 2015
- 2. Microsoft Power BI guidedlearning.

CourseOutcomes:

The student will be ableto

- Understand the essentials of data analytics and the corresponding terminologies
- Determine the relevance of data tobusiness
- Be familiar with the steps involved in the analyticsprocess
- Understand and use statistical and graphical analysis to bring insights out from thedata
- Understand and use BI tools to present data in the form of Dashboards and reports



III Year - II Semester		L	Τ	Р	С
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	PATTERN RECOGNITION				
	(Professional Elective 2)				

Course Objectives

- To equip students with basic mathematical and statistical techniques commonly used in Patternrecognition.
- To introduce students to a variety of pattern recognitionalgorithms.
- Enable students to apply machine learning concepts in real lifeproblems.

Unit I

Introduction to Pattern Recognition: Problems, applications, design cycle, learning and adaptation, examples, Probability Distributions, Parametric Learning - Maximum likelihood and Bayesian Decision Theory- Bays rule, discriminate functions, loss functions and Bayesian error analysis

Unit II

Linear models: Linear Models for Regression, linear regression, logistic regression Linear Models for Classification

Unit III

Neural Network: perception, multi-layer perception, back propagation algorithm, error surfaces, practical techniques for improving back propagation, additional networks and training methods, Ad boost, Deep Learning

Unit IV

Linear discriminate functions - decision surfaces, two-category, multi-category, minimumsquared error procedures, the Ho-Kashyap procedures, linear programming algorithms, Support vector machine

Unit V

Algorithm independent machine learning – lack of inherent superiority of any classifier, bias and variance, re-sampling for classifier design, combining classifiers

Unsupervised learning and clustering – k-means clustering, fuzzy k-means clustering, hierarchical clustering

TEXT BOOKS:

- 1. Richard O. Duda, Peter E. Hart, David G. Stork, "Pattern Classification", 2nd Edition John Wiley & Sons, 2001.
- 2. Machine learning by Saikat Dutt, S. Chandramouli and A.K.Das , Pearson publishing,2018.



REFERENCE BOOKS:

- 1. C. Bishop, "Pattern Recognition and Machine Learning", Springer, 2006
- 2. Trevor Hastie, Robert Tibshirani, Jerome H. Friedman, "The Elements of Statistical Learning", 2nd Edition, Springer, 2009.

Course Outcomes:

At the end of this course, students will be able to

- Study the parametric and linear models forclassification
- Design neural network and SVM forclassification
- Develop machine independent and unsupervised learningtechniques.



III Year - II Semester		L	Т	Р	С
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	ROBOTICS and AUTOMATION				
	(Professional Elective 2)				

OBJECTIVE:

To impart knowledge about basic mathematics related to industrial robots for their control, design and application in robotics & automationIndustries.

UNIT – I

Introduction to Robotics

Types and components of a robot, classification of robots

Study components of an industrial robot (PUMA, KUKA, FANUC, MTAB, UR, etc.) and its DH parameters.

UNIT – II

Robot Kinematics and Dynamics:

Kinematic Modelling: Translation and Rotation Representation, Coordinate transformation, DH parameters, Forward and inverse kinematics, Jacobian, Singularity, and Statics.

Dynamic Modelling: Forward and inverse dynamics, Equations of motion using Euler-Lagrange formulation, Newton Euler formulation.

Sensors

Sensor: Contact and Proximity, Position, Velocity, Force, Tactile etc. Introduction to Cameras, Camera calibration, Geometry of Image formation, Euclidean / Similarity / Affine / Projective transformations, Vision applications in robotics

UNIT – III

Robot Actuation Systems

Actuators: Electric, Hydraulic and Pneumatic; Transmission: Gears, Timing Belts and Bearings, Parameters for selection of actuators.

Robot Control:

Robot control, Independent joint control, PD and PID feedback, actuator models, nonlinearity of manipulator models, issues in nonlinear control, force feedback, hybrid control, Motion Planning, Obstacle avoidance, configuration space, road map methods, graph search algorithms, potential fieldmethods

$\mathbf{UNIT} - \mathbf{IV}$

Control Hardware and Interfacing:

Embedded systems: Microcontroller Architecture and integration with sensors, actuators, components, Programming Applications for Industrial robot - programming in – VAL II **Case Study:** Bin Picking in Industrial Warehouse.



UNIT – V AI in Robotics:

Applications in unmanned systems, defence, medical, industries, Robotics and Automation for Industry 4.0 Robot safety and social robotics

TEXTBOOKS:

- 1. Introduction to Robotics Mechanics and Control, John J. Craig, 3rd Edition, Pearson Prentice Hall,2004.
- 2. Industrial Robots, Groover M. P. and Ashish Dutta, McGrawHill,2012
- 3. Robots Dynamics & Control, Spong M. W. and Vidyasagar M., John Wiley & Sons (ASIA) PteLtd.

REFERENCE BOOKS

- Introduction to Robotics: Analysis, Control, Applications, Saeed B. Niku, 3rdEdition, Wiley,2019
- 2. Robotics Engineering, R. Klafter, PHI.
- 3. Robotics, Subir K. Saha, McGrawHill.

Course Outcomes:

The student will be able to:

- Perform kinematic and dynamic analyses with simulation.
- Design control laws for a simplerobot.
- Integrate mechanical and electrical hardware for a real prototype of robotic device.
- Select a robotic system for given industrial application.



III Year - II Semester		L	Т	P	С
		3	0	0	3
	Data Mining				
	Open Elective (OE1)				

Course objectives:

The main objectives of this course are:

- Students will be enabled to understand and implement classical models and algorithms in data warehousing and datamining.
- They will learn how to analyze the data, identify the problems, and choose the relevant models and algorithms to apply.
- They will further be able to assess the strengths and weaknesses of various methods and algorithms and to analyze theirbehavior.

UNIT-I:

INTRODUCTION: Need of Data Warehouse, Need and Usage of Data Mining Technologies, Types of Data and Patterns to be mined, In Real Time Applications. Brief Introduction of Pattern Recognition: Pattern, Feature, Database Query Vs Mining, Curse of Dimensionality, Need for Efficiency. Major Issues in Data Mining. Data Objects and Attribute Types, Basic Statistical Descriptions of Data, Data Visualization, Measuring Data Similarity and Dissimilarity

UNIT-II:

DATA PRE-PROCESSING: Data Preprocessing: An Overview, Data Cleaning, Data Integration, Data Reduction, Data Transformation and Data Discretization

UNIT-III:

CLASSIFICATION: Basic Concepts, General Approach to solving a classification problem, Decision Tree Induction: Working of Decision Tree, building a decision tree, methods for expressing an attribute test conditions, measures for selecting the best split, Algorithm for decision tree induction. Bayes' Theorem, Naïve Bayesian Classification, Bayesian Belief Networks

UNIT-IV:

ASSOCIATION ANALYSIS: BASIC CONCEPTS AND ALGORITHMS: Problem Defecation, Frequent Item Set generation, Rule generation, compact representation of frequent item sets, FP-Growth Algorithm. (**Tan &Vipin**)

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UNIT-V:

CLUSTER ANALYSIS: BASIC CONCEPTS AND ALGORITHMS: OVERVIEW: Basics and Importance of Cluster Analysis, Clustering techniques, Different Types of Clusters; Kmeans: The Basic K-means Algorithm, K-means Additional Issues, Bisecting K-means, Strengths and Weaknesses; Agglomerative Hierarchical Clustering: Basic Agglomerative Hierarchical Clustering Algorithm DBSCAN:Traditional Density Center-Based Approach, DBSCAN Algorithm, Strengths and Weaknesses. (**Tan&Vipin**)

TEXT BOOKS:

1. Introduction to Data Mining: Pang-Ning Tan & Michael Steinbach, Vipin Kumar, Pearson.

2. Data Mining concepts and Techniques, 3/e, Jiawei Han, Michel Kamber, Elsevier.

REFERENCE BOOKS:

- 1. Data Mining Techniques and Applications: An Introduction, Hongbo Du, CengageLearning.
- 2. Data Mining: VikramPudi and P. Radha Krishna, Oxford.
- 3. Data Mining and Analysis Fundamental Concepts and Algorithms; Mohammed J.Zaki, Wagner Meira, Jr,Oxford
- 4. Data Warehousing Data Mining & OLAP, Alex Berson, Stephen Smith, TMH.
- 5. http://onlinecourses.nptel.ac.in/noc18_cs14/preview (NPTEL course by Prof.PabitraMitra)
- http://onlinecourses.nptel.ac.in/noc17_mg24/preview (NPTEL course by Dr. Nandan Sudarshanam& Dr. Balaraman Ravindran)

http://www.saedsayad.com/data_mining_map.htm

Course Outcomes:

At the end of this course the student will be able to:

- Understand Data MiningPrinciples
- Identify appropriate data mining algorithms to solve real world problems
- Compare and evaluate different data mining techniques like classification, prediction, clustering and association rulemining



III Year - II Semester		L	Т	Р	С
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	POWER FLECTRONICS				
	Open Elective (OE1)				

Course objectives:

The main objectives of this course are:

- To study the characteristics of various power semiconductor devices and gate drivecircuits.
- To understand the operation of single phase full-wave converters and analyze harmonics in the inputcurrent.
- To study the operation of three phase full-waveconverters.
- To understand the operation of different types of DC-DCconverters.
- To understand the operation of inverters and application of PWM techniques forvoltage control and harmonic mitigation.

UNIT-I:

Power Semiconductor Devices: Operation of SCR, power MOSFET and power IGBT and their characteristics–Gate drive circuits for SCR, IGBT and MOSFET-protection circuits for power IGBT and power MOSFETs.

UNIT-II:

AC-DC Single-Phase Converters: 1-phase fully-controlled bridge rectifiers feeding R load, RL, RLE loads (continuous and discontinuous current conduction mode of operation)– 1-phase semi-controlled bridge rectifiers feeding R, RL and RLE loads (continuous and discontinuous current conduction mode of operation)– HarmonicAnalysis.

UNIT-III:

AC-DC Three-Phase Converters: 3-phase Full converter feeding R, RL and RLE loads (continuous current conduction mode only)– 3-phase semi-converter feeding R, RL and RLE loads (continuous current conduction mode only)–Harmonic analysis -Dual converter.

UNIT-IV:

DC–DC Converters: Analysis of Buck, boost, buck-boost converters in Continuous Conduction Mode (CCM) and Discontinuous Conduction Modes (DCM) – Output voltage equations using volt-sec balance in CCM & DCM- output voltage ripple & inductor current ripple for CCM only – Principle operation of forward and fly back converters inCCM.

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UNIT – V:

DC–AC Converters and AC-AC converters: 1- phase half-bridge and full bridge inverters with R and RL loads – Unipolar and bipolar switching-Quasi-square wave pulse width modulation-3-phase square wave inverters – 120° conduction and 180° conduction modes of operation – Sinusoidal pulse width modulation –single-phase Current Source Inverter (CSI)-single-phase AC-AC voltage regulator with R and RLload.

TEXT BOOKS:

- 1. Power Electronics: converters, applications & design -by Nedmohan, Tore M.Undeland, Robbins by Wiley India Pvt.Ltd.
- 2. Power Electronics- by Daniel W.Hart, Mc Graw Hillpublications
- 3. Power Electronics: Circuits, Devices and Applications by M. H. Rashid, Prentice Hallof India

REFERENCE BOOKS:

- 1. Power Electronics: Essentials & Applications by L.Umanand, Wiley, Pvt. Limited, India, 2009
- 2. Elements of Power Electronics-Philip T.Krein. Oxfordpublishers.
- 3. Power Electronics by P.S.Bhimbra, KhannaPublishers.

Course Outcomes:

At the end of this course the student will be able to:

- Explain the characteristics of various power semiconductor devices and understand the gate drivercircuits.
- Explain the operation of single-phase full wave converters and performharmonic analysis.
- Explain the operation of three phase full–wave converters and performharmonic analysis.
- Analyze the operation of different types of DC-DCconverters.
- Explain the operation of inverters and application of PWM techniques for voltagecontrol and harmonicmitigation.



III Year - II Semester		L	Т	Р	С
		3	0	0	3
MEMS and its applications					
	Open Elective (OE1)				

Course objectives:

- To introduce the basic concepts of micro systems and advantages of miniaturization.
- To study the various materials and their properties used for micromachiningtechniques.
- To analyze the fundamentals of micromachining and micro fabricationtechniques.
- To impart knowledge of the basic concept of electromechanical effects, thermal effects Micro fluidics and Integratedfluidicsystems.
- To study the fundamentals of pressure sensors and accelerometer sensors throughdesign andmodeling.

UNIT I: Overview of MEMS and Microsystems: MEMS and Microsystems, Typical MEMS and Microsystem products, Evolution of Microfabrication, Microsystem and Microelectronics, The Multidisciplinary nature of microsystem design and manufacture, Microsystem and Miniaturization. Application of Microsystems in the automotive industry, Application of Microsystems in other industries: Health care industry, Aerospace industry, Industrial products, Consumer products, Telecommunications. Markets for Microsystems.

UNIT II: Working Principles of Microsystems: Introduction, Microsensors: Acoustic Wave Sensors, Biomedical sensors and Biosensors, Chemical sensors, Pressure sensors, Thermal sensors. Micro actuation: Actuation using thermal forces, shaped memory alloys, Piezoelectric crystals, Electrostatic forces. MEMS with Micro actuators: Microgrippers, Micromotors, Microvalves, Micropumps, Micro accelerators, Microfluidics.

UNIT III: Scaling Laws in Miniaturization: Introduction to scaling, Scaling in Geometry, Scaling in Rigid-Body Dynamics, Scaling in Electrostatic Forces, Scaling in Electromagnetic Forces, Scaling in Electricity, Scaling in Fluid Mechanics, Scaling in Heat Transfer.

Materials for MEMS and Microsystems: Introduction, Substrates and wafers, Active substrate materials, Silicon as a substrate material. Silicon compounds, Silicon piezo resistors, Gallium Arsenide, Quartz, Piezoelectric crystals, Polymers, Packing materials.

UNIT IV: Micro system Fabrication Process: Photolithography, Ion Implantation, Diffusion, Oxidation, ChemicalVapourDeposition, PhysicalVapourDeposition, Deposition by Epitaxy, Etching.

Overview of Micro manufacturing and Applications: Bulk Micro manufacturing- any one example of application, Surface Micromachining- any one example of application. LIGA Process- any one example of application.

UNIT V:Applications of MEMS-Switching: Introduction, Switch parameters, Basics of switching, Mechanical switches, Electronic switches for RF and microwave applications, Mechanical RF switches, PIN diode RF switches.

Text Books:

1. Tai-Ran Hsu, "MEMS and Microsystems: Design and Manufacture", Tata McGraw Hill, (2002).

2. Gabriel M. Rebeiz, "RF MEMS Theory, Design and Technology", Wiley India PvtLtd.

Reference Books:

1. Stephen D. Senturia, "Microsystem Design", Springer International Edition, (2010).

2. Mohamed Gad-el-Hak, "The MEMS Handbook", CRC Press,(2002).

3. Chang Liu, "Foundations of MEMS", Second Edition, PearsonPublication.

E-resources:

- 1. https://nptel.ac.in/courses/117105082/4
- 2. <u>https://ocw.mit.edu/courses/electrical-engineering-and-computer-science/6-777j-design-and-fabrication-of-microelectromechanical-devices-spring-2007/lecture-notes/</u>
- 3. <u>https://www.edx.org/course/micro-nanofabrication-mems-epflx-memsx-0</u>

Course Outcomes:

- Understand the basic overview of MEMS and Microsystems with broad category of MEMS & Micro systemapplications.
- Understanding the working principles of Microsystems
- Understand the Scaling Laws in Miniaturization and Materials for MEMS and Microsystems
- Understand the Micro system Fabrication Process and Analyze the different Micro manufacturing process and Applications.
- Study and Analyze the different types of RF switches, Various Switching Mechanismand theirapplications..



III Year - II Semester		L	Т	P	С	
		3	0	0	3	
Artificial Neural Networks						
	Open Elective (OE1)					

Course objectives:

The main objectives of this course are:

- To provide an introduction to thefield of artificial neural networks and machinelearning.
- To teach students how to solve practical problems via implementation of these techniques via simulation.
- To promote further independent learning on the topics of artificial neural networks and machinelearning.

UNIT-I:

INTRODUCTION: History of Neural Networks, Structure and Functions of Biological and Artificial Neuron, Neural Network Architectures, Characteristics of ANN, Basic Learning Laws and Methods.

UNIT-II:

SUPERVISED LEARNING: Single Layer Neural Network and architecture, McCulloch-Pitts Neuron Model, Learning Rules, Perceptron Model, Perceptron Convergence Theorem, Delta learning rule, ADALINE, Multi-Layer Neural Network and architecture, MADALINE, Back Propagation learning, Back Propagation Algorithm.

UNIT-III:

UNSUPERVISED LEARNING-1: Outstar Learning, Kohenen Self Organization Networks, Hamming Network And MAXNET, Learning Vector Quantization, Mexican hat.

UNIT-IV:

UNSUPERVISED LEARNING-2: Counter Propagation Network -Full Counter Propagation network, Forward Only Counter Propagation Network, Adaptive Resonance Theory (ART) - Architecture, Algorithms.

UNIT V:

ASSOCIATIVE MEMORY NETWORKS: Introduction, Auto Associative Memory, Hetero Associative Memory, Bidirectional Associative Memory(BAM) -Theory and Architecture, BAM Training Algorithm, Hopfield Network: Introduction, Architecture of Hopfield Network.

TEXT BOOKS:

- 1. B. Yegnanarayana" Artificial neural networks" PHI, New Delhi.
- 2. S.N. Sivanandam, S.N. Deepa, "Introduction to Neural Networks using MATLAB6.0", TATA MCGraw- Hillpublications.
- 3. J.M. Zurada," Introduction to Artificial neural systems" Jaicopublishing.

REFERENCE BOOKS:

- 1. S.Rajasekaran and G.A.Vijayalakshmipai "Neural Networks.Fuzzy Logicand genetic Algorithms".
- 2. James A Freeman and Davis Skapura" Neural Networks Algorithm, applications and programming Techniques", Pearson Education, 2002.
- 3. Simon Hakins "Neural Networks " PearsonEducation.

Course Outcomes:

At the end of this course the student will be able to:

- Survey of attractive applications of Artificial NeuralNetworks.
- practically approach for using Artificial Neural Networks in various technical, organizational and economicapplications



III Year - II Semester	L	Т	P	С
	3	0	0	3

INTERNET OF THINGS

Course Objectives:

- To learn and understand elements of IoTsystem.
- Acquire knowledge about various protocols ofIoT.
- To learn and understand design principles and capabilities of IoT.

UNIT I: Introduction to IoT

Introduction to IoT, Architectural Overview, Design principles and needed capabilities, Basics of Networking, M2M and IoT Technology Fundamentals- Devices andgateways, Data management, Business processes in IoT, Everything as a Service (XaaS), Role ofCloud in IoT, Security aspects inIoT.

UNIT II: Elements of IoT

Hardware Components- Computing- Arduino, Raspberry Pi, ARM Cortex-A class processor, Embedded Devices – ARM Cortex-M class processor, Arm Cortex-M0 Processor Architecture, Block Diagram, Cortex-M0 Processor Instruction Set, ARM and Thumb Instruction Set.

UNIT III: IoT Application Development

Communication, IoT Applications, Sensing, Actuation, I/O interfaces.

Software Components- Programming API's (using Python/Node.js/Arduino) for CommunicationProtocols-MQTT, ZigBee, CoAP, UDP, TCP, Bluetooth.

Bluetooth Smart Connectivity

Bluetooth overview, Bluetooth Key Versions, Bluetooth Low Energy (BLE) Protocol, Bluetooth, Low Energy Architecture, PSoC4 BLE architecture and Component Overview.

UNIT IV: Solution framework for IoT applications

Implementation of Device integration, Data acquisitionand integration, Device data storage-Unstructured data storage on cloud/local server, Authentication, authorization of devices.

UNIT V: IoT Case Studies

IoT case studies and mini projects based on Industrial automation, Transportation, Agriculture, Healthcare, HomeAutomation.

Text Books:

- 1. Raj Kamal, "Internet of Things: Architecture and Design Principles", 1st Edition, McGraw Hill Education, 2017.
- 2. The Definitive Guide to the ARM Cortex-M0 by JosephYiu,2011
- 3. Vijay Madisetti, ArshdeepBahga, Internet of Things, "A Hands on Approach", UniversityPress,2015.



References:

- 1. Cypress Semiconductor/PSoC4 BLE (Bluetooth Low Energy) Product TrainingModules.
- 2. Pethuru Raj and Anupama C. Raman, "The Internet of Things: EnablingTechnologies, Platforms, and Use Cases", CRC Press, 2017.

Course Outcomes:

The student will be able to:

- Understand internet of Things and its hardware and softwarecomponents.
- Interface I/O devices, sensors & communication modules.
- Remotely monitor data and controldevices.
- Design real time IoT basedapplications



III Year - II Semester	L	Т	Р	С
	0	0	3	1.5
VLSI LAB				

List of Experiments

PART (A): FPGA Level Implementation (Any Seven Experiments)

Note 1: The students need to develop Verilog /VHDLSource code, perform simulation using relevant simulator and analyze the obtained simulation results using necessary Synthesizer.

Note 2: All the experiments need to be implemented on the latest FPGA/CPLD Hardware in the Laboratory

1. Realization of Logic gates

Design and Implementation of the following:

- 2. 4-bit ripple carry and carry look ahead adder using behavioural, dataflow and structural modeling
- 3. a) 16:1 mux through 4:1 mux
- b) 3:8 decoder realization through 2:4 decoder
- 4. 8:3 encoder
- 5. 8-bit parity generator and checker
- 6. Flip-Flops
- 7. 8-bit synchronous up-down counter
- 8. 4-bit sequence detector through Mealy and Moore state machines.

EDA Tools/Hardware Required:

- 1. EDA Tool that supports FPGA programming including Xilinx Vivado /Altera (Intel)/ Cypress/Equivalent Industry standard tool along with corresponding FPGA hardware.
- 2. Desktop computer with appropriate Operating System that supports the EDA tools.

PART (B): Back-end Level Design and Implementation (Any Five Experiments)

Note: The students need to design the following experiments at schematic level using CMOS logic and verify the functionality. Further students need to draw the corresponding layout and verify the functionality including parasites. Available state of the art technology libraries can be used while simulating the designs using Industry standard EDA Tools.

Design and Implementation of the following

- a. Universal Gates
- b. An Inverter
- 2. Full Adder
- 3. Full Subtractor



- 4. Decoder
- 5. D-Flip-flop

EDA Tools/Hardware Required:

- Mentor Graphics Software / Cadence/Synopsys/Tanner or Equivalent Industry Standard/CAD Tool.
- Desktop computer with appropriate Operating System that supports the EDA tools.



III Year - II Semester	L	Т	P	С
	0	0	3	1.5

DIGITAL SIGNAL PROCESSING LAB

(Note: Students have to perform at least FOUR experiments from each part.)

PART-A

List of the Experiments

- 1. Generation of DTsignals.
- 2. Verify the Linear Convolution of two DT signals
 - a) UsingMATLAB
 - b) Using Code ComposerStudio(CCS)
- 3. Verify the Circular Convolution of two DTsignals
 - a) UsingMATLAB
 - b) Using Code ComposerStudio(CCS)
- 4. Find the sum of DT sinusoidalsignals.
- 5. Computation of Discrete Fourier Transform (DFT) and Inverse DiscreteFourier Transform(IDFT)
 - a) UsingMATLAB
 - b) Using Code ComposerStudio(CCS)
- 6. Transfer Function Stability Analysis: using pole-zero plot, bode plot and Nyquist plot.

PART-B

Following Experiments are to be done using a TI DSP Starter Kit.

- 7. Generation of a sinusoidal signal.
- 8. Linear and circular convolution of DTsequences.
- 9. Compute N-point DFT of a given DTsequence.
- 10. Design and implementation of FIRfilters.
- 11. Design and implementation of IIR filters.

PART-C

Following Experiments are to be done using Cypress FM4 Starter Kit.

- 12. Verification of samplingtheorem.
- 13. Implementation of FFTalgorithm.
- 14. Implementation of FIR filters.
- 15. Implementation of IIR filters.



III Year - II Semester	L	Т	P	С
	3	0	0	0
Intellectual Prop	ty Rights (IPR) & Patants			

UNIT I

Introduction to Intellectual Property Rights (IPR): Concept of Property - Introduction to IPR – International Instruments and IPR - WIPO - TRIPS – WTO -Laws Relating to IPR - IPR Tool Kit - Protection and Regulation - Copyrights and Neighboring Rights – Industrial Property – Patents - Agencies for IPR Registration – Traditional Knowledge –Emerging Areas of IPR - Layout Designs and Integrated Circuits – Use and Misuse of Intellectual PropertyRights.

UNIT II

Copyrights and Neighboring Rights: Introduction to Copyrights – Principles of Copyright Protection – Law Relating to Copyrights - Subject Matters of Copyright – Copyright Ownership – Transfer and Duration – Right to Prepare Derivative Works –Rights of Distribution – Rights of Performers – Copyright Registration – Limitations – Infringement of Copyright – Relief and Remedy – Case Law - Semiconductor Chip ProtectionAct.

UNIT III

Patents: Introduction to Patents - Laws Relating to Patents in India – Patent Requirements – Product Patent and Process Patent - Patent Search - Patent Registration and Granting of Patent -Exclusive Rights – Limitations - Ownership and Transfer — Revocation of Patent – Patent Appellate Board - Infringement of Patent – Compulsory Licensing — Patent Cooperation Treaty – New developments in Patents – Software Protection and Computer relatedInnovations

UNIT IV

Trademarks: Introduction to Trademarks – Laws Relating to Trademarks – Functions of Trademark – Distinction between Trademark and Property Mark – Marks Covered under Trademark Law - Trade Mark Registration – Trade Mark Maintenance – Transfer of rights - Deceptive Similarities

Likelihood of Confusion - Dilution of Ownership – Trademarks Claims and Infringement – Remedies – Passing Off Action.

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UNIT V

Trade Secrets & Cyber Law and Cyber Crime: Introduction to Trade Secrets – General Principles - Laws Relating to Trade Secrets–

Maintaining Trade Secret – Physical Security – Employee Access Limitation – Employee Confidentiality Agreements – Breach of Contract –Law of Unfair Competition – Trade Secret Litigation – Applying State Law.

Cyber Law – Information Technology Act 2000 - Protection of Online and Computer Transactions –

E-commerce - Data Security - Authentication and Confidentiality - Privacy - Digital Signatures

– Certifying Authorities - Cyber Crimes - Prevention and Punishment – Liability of Network Providers.

References:

- 1) Intellectual Property Rights (Patents & Cyber Law), Dr. A. Srinivas. Oxford University Press, NewDelhi.
- 2) Deborah E.Bouchoux: Intellectual Property, Cengage Learning, NewDelhi.
- 3) PrabhuddhaGanguli: Intellectual Property Rights, Tata Mc-Graw –Hill, NewDelhi
- 4) Richard Stim: Intellectual Property, Cengage Learning, NewDelhi.
- 5) Kompal Bansal & Parishit Bansal Fundamentals of IPR for Engineers, B. S. Publications (Press).
- 6) Cyber Law Texts & Cases, South-Western's Special TopicsCollections.
- 7) R.Radha Krishnan, S.Balasubramanian: Intellectual Property Rights, Excel Books. New Delhi.
- 8) M.Ashok Kumar and MohdIqbal Ali: Intellectual Property Rights, SerialsPub.

Course Outcomes:

- IPR Laws and patents pave the way for innovative ideas which are instrumental for inventions to seekPatents
- Student get an insight on Copyrights, Patents and Software patents which are instrumental for furtheradvancements
- advanced Technical and Scientific disciplines
- Imparting IPR protections and regulations for further advancement, so that the students can familiarize with the latest developments